





S3AB THRU S3MB 3.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER



Features

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop
- Low Power Loss
- Built-in Strain Relief
- Plastic Case Material has UL Flammability Classification Rating 94V-0
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: SMB molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- . Polarity: Color band denotes cathode end
- Mounting Position: AnyWeight: 0.09 grams

Maximum Ratings and Electrical Characteristics @TA=25°C unless otherwise specified

Characteristic	Symbol	S3AB	S3BB	S3DB	S3GB	S3JB	S3KB	S3MB	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Average forward rectified output current @T _L = 75°C	Io				3.0				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	100			А				
Forward Voltage @I _F =3.0A	V _{FM}	1.20			V				
Peak Reverse Current @T _A = 25°C At Rated DC Blocking Voltage @T _A = 125°C	I _{RM}	5.0 250			μA				
Typical Junction Capacitance (Note 1)	1) C _J 60				pF				
Typical Thermal Resistance (Note 2)	R _{θJL}	13				K/W			
Operating and Storage Temperature Range	T _{J,} T _{STG}	-65 to +150				°C			

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

2. Mounted on P.C.B.with 8.0mm² land areas.







Ratings and Characteristics Curves

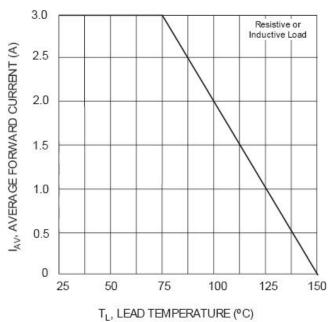


Fig. 1 Forward Current Derating Curve

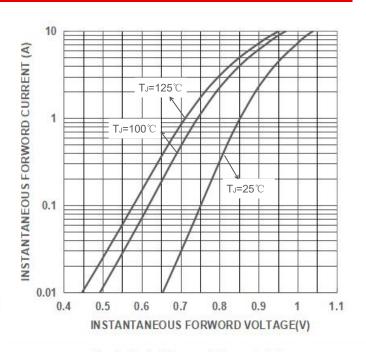
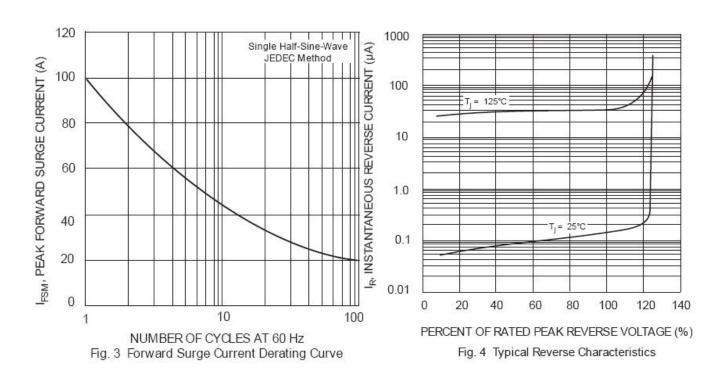


Fig. 2 Typical Forward Characteristics



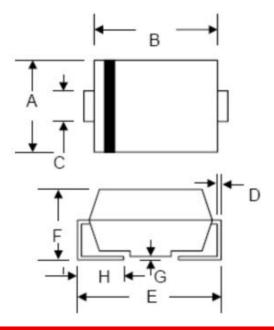
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Mechanical Dimensions SMB



SYMBOL	Millir	neters	Inches		
SYMBOL	Min. Max.		Min.	Max.	
Α	3.30	3.94	0.130	0.155	
В	4.06	4.70	0.160	0.185	
С	1.80	2.20	0.071	0.087	
D	0.152	0.305	0.006	0.012	
E	4.80	5.59	0.189	0.220	
F	2.10	2.60	0.083	0.102	
G	0.051	0.203	0.002	0.008	
Н	0.76	1.52	0.030	0.060	

Ordering Information

Device	Package	Shipping		
S3AB-S3MB	SMB(Pb-Free)	3000pcs / reel		
S3ABTR-S3MBTR	SMB(Pb-Free)	3000pcs / reel		

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

 S3AB
 = Part Name

 YY
 = Year

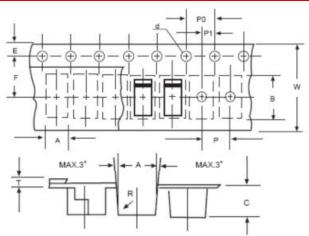
 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape Specification SMB



SYMBOL	Millimeters			
	Min.	Max.		
Α	3.99	4.19		
В	5.72	5.92		
С	3.23	3.43		
d	1.40	1.60		
E	1.40	1.60		
F	5.60	5.70		
Р	7.90	8.10		
P0	3.90	4.10		
P1	1.90	2.10		
Т	-	0.60		
W	11.80	12.20		

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